	Type	Hits	Search Text	DBs
	IS&R	0	("e23.021,e23.069,e23.07,e23.123,e23.1	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB
7	IS&R	0	("e23.021") or ("e23.069") or ("e23.123") or ("e23.133")).PN.	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM TDB
3	BRS	6	"e23.021" "e23.069" "e23.07" "e23.123" "e23.124" "e23.133"	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB
4	IS&R .	2803	(174/52.2,52.3).ccls.	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB
5	IS&R	0	("scribeand4").PN.	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM TDB
9	BRS	15	scribe and S4	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM TDB
7	BRS	171	ball and S4	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB
<b>&amp;</b>	BRS	732	solder and S4	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB
<u>ი</u>	BRS	326	(stress or strain or tension or compression) and S8	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB
10	BRS	343	(stress or strain or tension or compression or tensile or compress or compressive) and S8	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB

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	Type	HITS	Search Text	DBS
				-PGPU
<del>디</del>	IS&R	718	(257/669).CCLS.	USOCR; EPO; JPO;
				DERWENT; IBM TDB
				US-PGPUB; USPAT;
12	IS&R	0	("11and@ad<20010316").PN.	USOCR; EPO; JPO;
				DERWENT; IBM_TDB
				-PGPU
13	BRS	618	S11 and @ad<"20010316"	USOCR; EPO; JPO;
				DERWENT; IBM_TDB
				-PGPU
14	BRS	129	S11 and @rlad<"20010316"	OCR; EP
				DERWENT; IBM_TDB
				sn :
15	BRS	653	S13 S14	USOCR; EPO; JPO;
				DERWENT; IBM_TDB
				-PGPU
16	BRS	0	257/738,780,787	USOCR; EPO; JPO;
				DERWENT; IBM_TDB
			•	-PGPUB
17	IS&R	5795	(257/738,780,787).CCLS.	USOCR; EPO; JPO;
				DERWENT; IBM_TDB
			(stress or strain or tension or	US-PGPUB; USPAT;
18	BRS	2218	compression or tensile or compress or	USOCR; EPO; JPO;
			compressive) and S17	DERWENT; IBM_TDB
				-PGPU
19	BRS	1497	S18 and @ad<"20010316"	USOCR; EPO; JPO;
				DERWENT; IBM TDB
				S-P
70	BRS	525	S18 and @rlad<"20010316"	$\vdash$
				DERWENT; IBM_TDB

	Type	Hıts	Search Text	DBS
				US-PGPUB; USPAT;
21	BRS	1698	S19 S20	USOCR; EPO; JPO;
				DERWENT; IBM TDB
				US-PGPUB; USPAT;
22	BRS	1145	solder and S21	USOCR; EPO; JPO;
				DERWENT; IBM_TDB
				-PGPUB
23	BRS	1090	S22 not S8	USOCR; EPO; JPO;
				DERWENT; IBM_TDB
				US-PGPUB; USPAT;
24	BRS	1067	S23 not S13	USOCR; EPO; JPO;
				DERWENT; IBM TDB
				US-PGPUB; USPAT;
25	IS&R	1786	(438/123-124).CCLS.	USOCR; EPO; JPO;
				DERWENT; IBM_TDB
			(stress or strain or tension or	US-PGPUB; USPAT;
26	BRS	720	compression or tensile or compress or	USOCR; EPO; JPO;
			compressive) and S25	DERWENT; IBM TDB
				US-PGPUB; USPAT;
27	BRS	434	S26 and @ad<"20010316"	USOCR; EPO; JPO;
				DERWENT; IBM_TDB
				US-PGPUB; USPAT;
<b>58</b>	BRS	326		USOCR; EPO; JPO;
				DERWENT; IBM_TDB
				S
29	BRS	555	S27 S28	USOCR; EPO; JPO;
				DERWENT; IBM_TDB